

# SMDA05C THRU SMDA24C Bidirectional TVS Array for Protection of Four Lines

### PROTECTION PRODUCTS

### Description

The SMDAxxC series of TVS arrays are designed to provide bidirectional protection for sensitive electronics from damage or latch-up due to ESD, lightning and other voltage-induced transient events. Each device will protect four data or I/O lines. They are available with operating voltages of 5V, 12V, 15V and 24V.

TVS diodes are solid-state devices designed specifically for transient suppression. They offer desirable characteristics for board level protection including fast response time, low operating and clamping voltage and no device degradation. The low profile SO-8 package allows the user to protect up to four independent lines with one package. The SMDAxxC series is suitable protection for sensitive semiconductors components such as microprocessors, ASICs, transceivers, transducers, and CMOS memory.

The SMDAxxC series devices may be used to meet the ESD immunity requirements of IEC 61000-4-2, level 4 for air and contact discharge.

### Features

- ◆ Transient protection for data lines to IEC 61000-4-2 (ESD) 15kV (air), 8kV (contact) IEC 61000-4-4 (EFT) 40A (5/50ns) IEC 61000-4-5 (Lightning) 12A (8/20µs)
- Bidirectional protection
- ◆ Small SO-8 package
- ◆ Protects four I/O lines
- Working voltages: 5V, 12V, 15V and 24V
- ◆ Low leakage current
- Low operating and clamping voltages
- Solid-state silicon avalanche technology

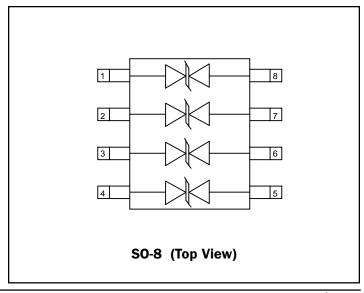
### **Mechanical Characteristics**

- ◆ JEDEC SO-8 package
- ◆ Molding compound flammability rating: UL 94V-0
- Marking: Part number, date code, logo
- Packaging: Tube or Tape and Reel per EIA 481

### **Applications**

- Data and I/O Lines
- Microprocessor based equipment
- ◆ Notebooks, Desktops, and Servers
- ◆ Instrumentation
- ◆ LAN/WAN equipment
- Peripherals
- Serial and Parallel Ports

### Schematic & PIN Configuration





# **SMDA05C THRU SMDA24C**

# **PROTECTION PRODUCTS**

# Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	$P_{pk}$	300	Watts
ESD Voltage (HBM per (IEC 61000-4-2)		>25	kV
Lead Soldering Temperature	T <sub>L</sub>	260 (10 sec.)	°C
Operating Temperature	T <sub>J</sub>	-55 to +125	°C
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C

# Electrical Characteristics

SMDA05C							
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units	
Reverse Stand-Off Voltage	$V_{_{\mathrm{RWM}}}$				5	٧	
Reverse Breakdown Voltage	$V_{_{BR}}$	I <sub>t</sub> = 1mA	6			V	
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 5V, T=25°C			20	μΑ	
Clamping Voltage	V <sub>c</sub>	I <sub>pp</sub> = 1A, tp = 8/20μs			9.8	٧	
Clamping Voltage	V <sub>c</sub>	$I_{pp} = 5A$ , tp = 8/20 $\mu$ s			11	٧	
Maximum Peak Pulse Current	I <sub>PP</sub>	tp = 8/20µs			17	А	
Junction Capacitance	C <sub>j</sub>	$V_R = OV, f = 1MHz$			350	pF	

SMDA12C							
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units	
Reverse Stand-Off Voltage	$V_{_{\mathrm{RWM}}}$				12	V	
Reverse Breakdown Voltage	$V_{_{BR}}$	I <sub>t</sub> = 1mA	13.3			V	
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 12V, T=25°C			1	μΑ	
Clamping Voltage	V <sub>c</sub>	I <sub>PP</sub> = 1A, tp = 8/20μs			19	V	
Clamping Voltage	V <sub>c</sub>	$I_{pp} = 5A$ , tp = 8/20 $\mu$ s			24	V	
Maximum Peak Pulse Current	I <sub>PP</sub>	tp = 8/20µs			12	Α	
Junction Capacitance	C <sub>j</sub>	V <sub>R</sub> = OV, f = 1MHz			120	pF	



# SMDA05C THRU SMDA24C

# **PROTECTION PRODUCTS**

# Electrical Characteristics (Continued)

SMDA15C						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	$V_{_{\mathrm{RWM}}}$				15	٧
Reverse Breakdown Voltage	$V_{_{BR}}$	I <sub>t</sub> = 1mA	16.7			٧
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 15V, T=25°C			1	μA
Clamping Voltage	V <sub>c</sub>	I <sub>pp</sub> = 1A, tp = 8/20μs			24	V
Clamping Voltage	V <sub>c</sub>	I <sub>PP</sub> = 5A, tp = 8/20μs			30	V
Maximum Peak Pulse Current	I <sub>PP</sub>	tp = 8/20µs			10	А
Junction Capacitance	C <sub>j</sub>	$V_R = OV, f = 1MHz$			75	pF

SMDA24C						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	$V_{_{\mathrm{RWM}}}$				24	V
Reverse Breakdown Voltage	$V_{_{BR}}$	I <sub>t</sub> = 1mA	26.7			V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 24V, T=25°C			1	μΑ
Clamping Voltage	V <sub>c</sub>	$I_{pp} = 1A, tp = 8/20\mu s$			43	V
Clamping Voltage	V <sub>c</sub>	$I_{pp} = 5A, tp = 8/20\mu s$			55	V
Maximum Peak Pulse Current	I <sub>PP</sub>	tp = 8/20µs			5	Α
Junction Capacitance	C <sub>j</sub>	$V_R = OV, f = 1MHz$			50	pF

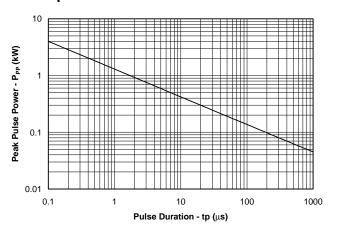




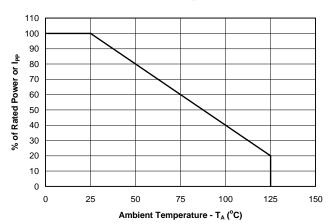
### PROTECTION PRODUCTS

### Typical Characteristics

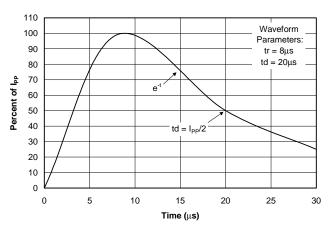
### Non-Repetitive Peak Pulse Power vs. Pulse Time



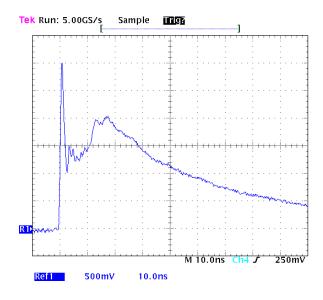
### **Power Derating Curve**



### **Pulse Waveform**



### ESD Pulse Waveform (IEC 61000-4-2)



### IEC 61000-4-2 Discharge Parameters

Level	First Peak Current	Peak Current at 30 ns	Peak Current at 60 ns	Test Voltage (Contact	Test Voltage (Air
	(A)	(A)	(A)	Discharge) (kV)	Discharge) (kV)
1	7.5	4	8	2	2
2	15	8	4	4	4
3	22.5	12	6	6	8
4	30	16	8	8	15





### **PROTECTION PRODUCTS**

### **Applications Information**

### **Device Connection for Protection of Four Data Lines**

The SMDAxxC series devices are designed to protect up to four data lines. The devices are connected as follows:

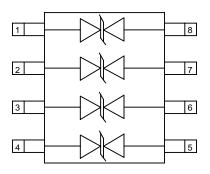
• The SMDAxxC are bidirectional devices and are designed for use on lines where the normal operating voltage is above and below ground. Pins 1, 2, 3, and 4 are connected to the protected lines. Pins 5, 6, 7, and 8 are connected to ground. Since the device is electrically symmetrical, these connections may be reversed. The ground connections should be made directly to the ground plane for best results. The path length is kept as short as possible to reduce the effects of parasitic inductance in the board traces.

# Circuit Board Layout Recommendations for Suppression of ESD.

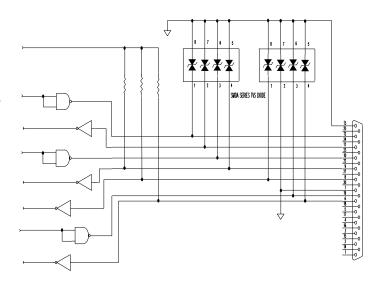
Good circuit board layout is critical for the suppression of ESD induced transients. The following guidelines are recommended:

- Place the TVS near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the TVS and the protected line.
- Minimize all conductive loops including power and ground loops.
- The ESD transient return path to ground should be kept as short as possible.
- Never run critical signals near board edges.
- Use ground planes whenever possible.

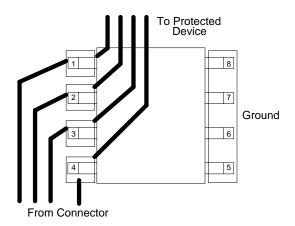
### **Circuit Diagram**



### I/O Line Protection



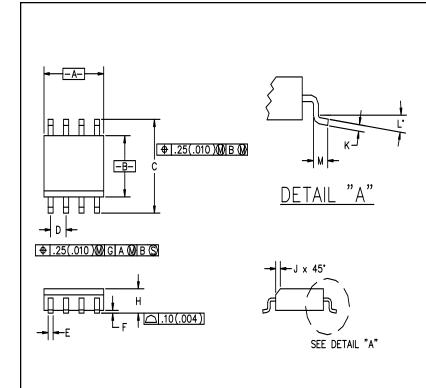
**Typical Connection** 





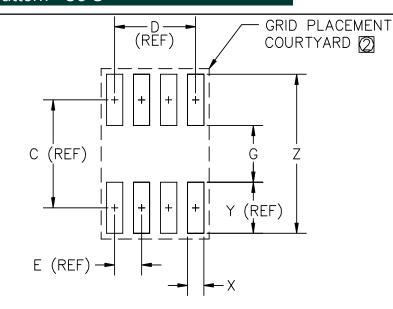
### **PROTECTION PRODUCTS**

### Outline Drawing - SO-8



DIMENSIONS							
DIMN	INC	HES	М	NOTE			
יואווט.	MIN	MAX	MIN	MAX	NOIL		
Α	.188	.197	4.80	5.00			
В	.149	.158	3.80	4.00			
$\bigcirc$	.228	.244	5.80	6.20			
	.050	BSC	1.27	BSC			
ш	.013	.020	0.33	0.51			
I-	.004	.010	0.10	0.25			
$\pm$	.053	.069	1.35	1.75			
<del>ر</del>	.011	.019	0.28	0.48			
Κ	.007	.010	.19	.25			
L	0°	8°	0°	8			
M	.016	.050	0.40	1.27			

### Land Pattern - SO-8



	DIMENSIONS (1)						
DIM	INCHES		М	М	NOTE		
ייואווט	MIN	MAX	MIN	MAX	NOIL		
С	_	.19	ı	5.00	-		
D	_	.15	ı	3.81	_		
Ε	_	.05	ı	1.27	_		
G	.10	.11	2.60	2.80	_		
Χ	.02	.03	.60	.80	1		
Y	_	.09		2.40	_		
Z	_	.29	7.20	7.40	_		

- GRID PLACEMENT COURTYARD IS 12x16 ELEMENTS (6 mm X 8mm) IN ACCORDANCE WITH THE INTERNATIONAL GRID DETAILED IN IEC PUBLICATION 97.
- (1) CONTROLLING DIMENSION: MILLIMETERS



# SMDA05C THRU SMDA24C

### **PROTECTION PRODUCTS**

# Ordering Information

Part Number	Working Voltage	Qty per Reel	Reel Size
SMDA05C.TB	5V	500	7 Inch
SMDA12C.TB	12V	500	7 Inch
SMDA15C.TB	15V	500	7 Inch
SMDA24C.TB	24V	500	7 Inch

### Note:

- (1) No suffix indicates tube pack.
- (2) Consult factory for availability of 13 Inch reels.

# Contact Information

Semtech Corporation Protection Products Division 652 Mitchell Rd., Newbury Park, CA 91320 Phone: (805)498-2111 FAX (805)498-3804